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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Bao, *et al.* Docket No: TSM03-0927
Filed: 3/15/2004 Art Unit: 2818
Serial No.: 10/800,510 Examiner: Tu-Tu Ho
For: Semiconductor Device Having a Second Level of Metallization Formed over a First Level with Minimal Damage to the First Level and Method

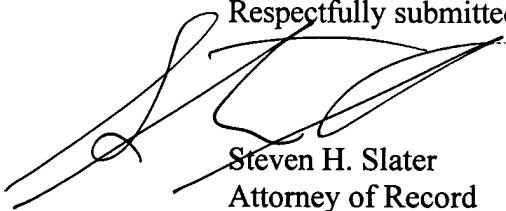
Mail Stop Amendment
Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

TRANSMITTAL OF REPLACEMENT FORMAL DRAWING

Dear Sir:

Submitted herewith is one replacement sheet of formal drawings for Figure 2g. This sheet replaces the informal drawing added by amendment on July 1, 2005, for the above-identified application.

Please contact Applicants' attorney with any questions regarding this matter.

Respectfully submitted,

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Certificate of Mailing via First Class Mail (37 C.F.R. § 1.8(a))

Date of Deposit: January 12, 2006

I hereby certify that the below listed correspondence is being deposited with the United States Postal Service on the date indicated above as first class mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P. O. Box 1450, Alexandria, VA 22313-1450.

Certificate of Mailing via First Class Mail (1 page)
Transmittal of Replacement Formal Drawing (1 page)
Replacement Formal Drawing Sheet (1 page)
Return Postcard

Respectfully submitted,

Natalie Swider
Legal Assistant

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